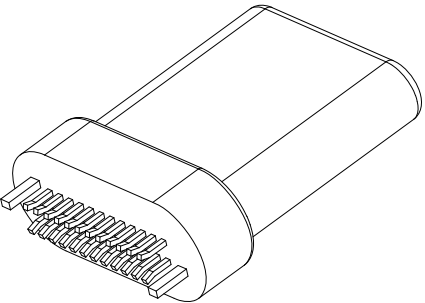
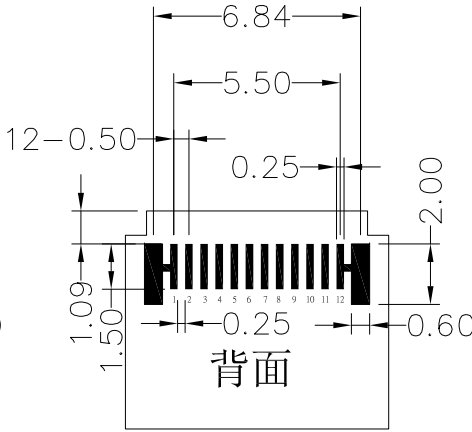
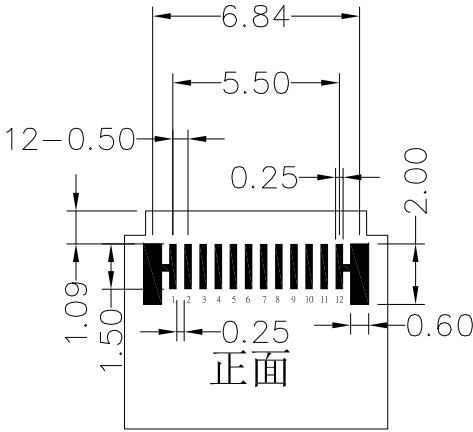
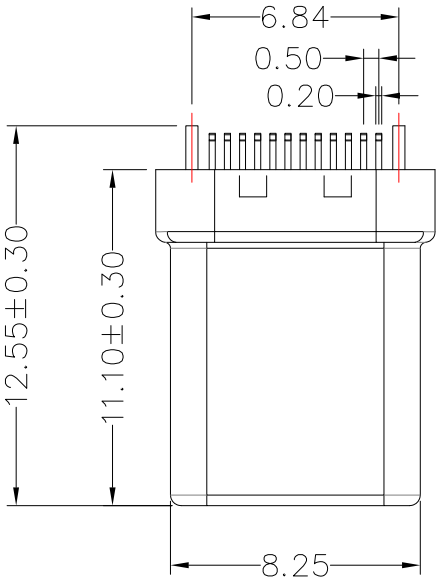




SBC-241PL26-31x-S271

鍍層厚度：

Blank : 1u"
2 : 15u"
3 : 30u"



PCB LATOUT

SPECIFICATIONS

Electrical:

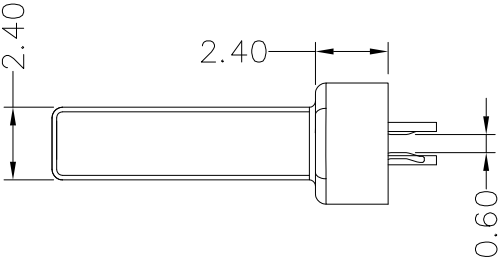
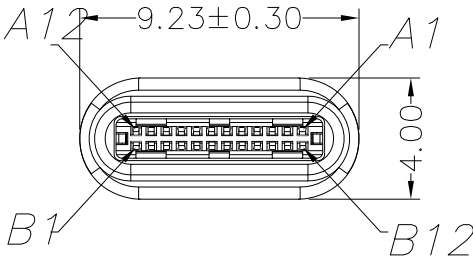
- 1.Current Rating: 0.5A
- 2.Contact Resistance: 30 mΩ Max
- 3.Dielectric Withstanding Voltage: 100 V AC
- 5.Insulation Resistance: 100 MΩ Min

Material:

- 1.Housing:LCP
- 2.Contact: Copper Alloy
- 3.Shell: SUS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



东莞市高迪电子有限公司
Dong Guan KDRR Electronic Switch Jack Co., Ltd.

TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE: 12/30/19
DATE: 12/30/19
DATE: 12/30/19

MATL
FINISH
SCALE: 1 : 1
SHEET NO. 1 of 1

TITLE: CONNECTOR
MODLE: TYPE C 公頭不帶板 拉伸款
DWG NO. SBC-241PL26-31x-S271
PART NO. SBC-241PL26-31x-S271

SIZE: A4
VER: R1

ITEM NO.	DESCRIPTION	DRAWN	DATE
1	更新PCB LAYOUT	Jack	123019